

Features

- ESD Protection for 1 Line with Bi-directional.
- Provide ESD protection for the protected line to
IEC 61000-4-2 (ESD) $\pm 16\text{kV}$ (air), $\pm 16\text{kV}$ (contact)
IEC 61000-4-4 (EFT) 50A (5/50ns)
IEC 61000-4-5 (Lightning) 4.5A (8/20 μs)
Cable Discharge Event (CDE)
- Ultra-small SOD-523 package saves board space.
- Protect one I/O line or one power line
- Fast turn-on and Low clamping voltage
- For low operating voltage applications: 3.3V maximum
- Solid-state silicon-avalanche and active circuit triggering technology
- Green Part

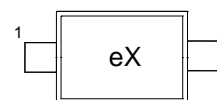
Applications

- Computer Interfaces Protection
- Microprocessors Protection
- Serial and Parallel Ports Protection
- Control Signal Lines Protection
- Power lines on PCB Protection
- Latchup Protection

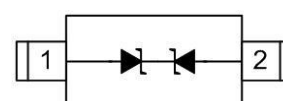
Description

AZ5123-01H is a design which includes a bi-directional surge rated clamping cell to protect one power line, or one control line, or one low speed data line in an electronic systems. The AZ5123-01H has been specifically designed to protect sensitive components which are connected to power and control lines from over-voltage damage and latch-up caused by Electrostatic Discharging (ESD), Electrical Fast Transients (EFT), Lightning, and Cable Discharge Event (CDE).

SOD-523



PIN Diagram



proprietary clamping cells in a single package. During transient conditions, the proprietary clamping cells prevent over-voltage on the power line or control/data lines, protecting any downstream components.

AZ5123-01H is bi-directional and may be used on lines where the signal swings above and below ground.

AZ5123-01H may be used to meet the ESD immunity requirements of IEC 61000-4-2, Level 4 ($\pm 15\text{kV}$ air, $\pm 8\text{kV}$ contact discharge).

ABSOLUTE MAXIMUM RATINGS			
PARAMETER	PARAMETER	RATING	UNITS
Peak Pulse Current (tp =8/20us)	I_{PP}	4.5	A
Operating Supply Voltage	V_{DC}	± 3.8	V
ESD per IEC 61000-4-2 (Air)	V_{ESD}	± 16	kV
ESD per IEC 61000-4-2 (Contact)		± 16	
Lead Soldering Temperature	T_{SOL}	260 (10 sec.)	$^{\circ}C$
Operating Temperature	T_{OP}	-55 to +85	$^{\circ}C$
Storage Temperature	T_{STO}	-55 to +150	$^{\circ}C$

ELECTRICAL CHARACTERISTICS						
PARAMETER	SYMBOL	CONDITIONS	MINI	TYP	MAX	UNITS
Reverse Stand-Off Voltage	V_{RWM}	$T=25^{\circ}C$.	-3.3		3.3	V
Reverse Leakage Current	I_{Leak}	$V_{RWM} = \pm 3.3V, T=25^{\circ}C$.			1	μA
Reverse Breakdown Voltage	V_{BV}	$I_{BV} = 1mA, T=25^{\circ}C$.	4		6.5	V
ESD Clamping Voltage	V_{ESD_CL}	IEC 61000-4-2 +6kV, $T=25^{\circ}C$, Contact mode.		7.5		V
Channel Input Capacitance	C_{IN}	$V_R = 0V, f = 1MHz, T=25^{\circ}C$.		13.5	16.5	pF

Applications Information

The AZ5123-01H is designed to protect one line against System ESD/EFT/Lightning pulses by clamping them to an acceptable reference. It provides bi-directional protection.

The usage of the AZ5123-01H is shown in Fig. 1. Protected line, such as data lines, control lines, or power lines, is connected at pin 1. The pin 2 is connected to a ground plane on the board. Since AZ5123-01H is bi-directional, these connections can be reversed (protected line to pin 2, ground to pin 1). In order to minimize parasitic inductance in the board traces, all path lengths connected to the pins of AZ5123-01H should be kept as short as possible.

In order to obtain enough suppression of ESD induced transient, good circuit board is critical. Thus, the following guidelines are recommended:

- Minimize the path length between the protected lines and the AZ5123-01H.
- Place the AZ5123-01H near the input terminals or connectors to restrict transient coupling.
- The ESD current return path to ground should be kept as short as possible.
- Use ground planes whenever possible.
- NEVER route critical signals near board edges and near the lines which the ESD transient easily injects to.

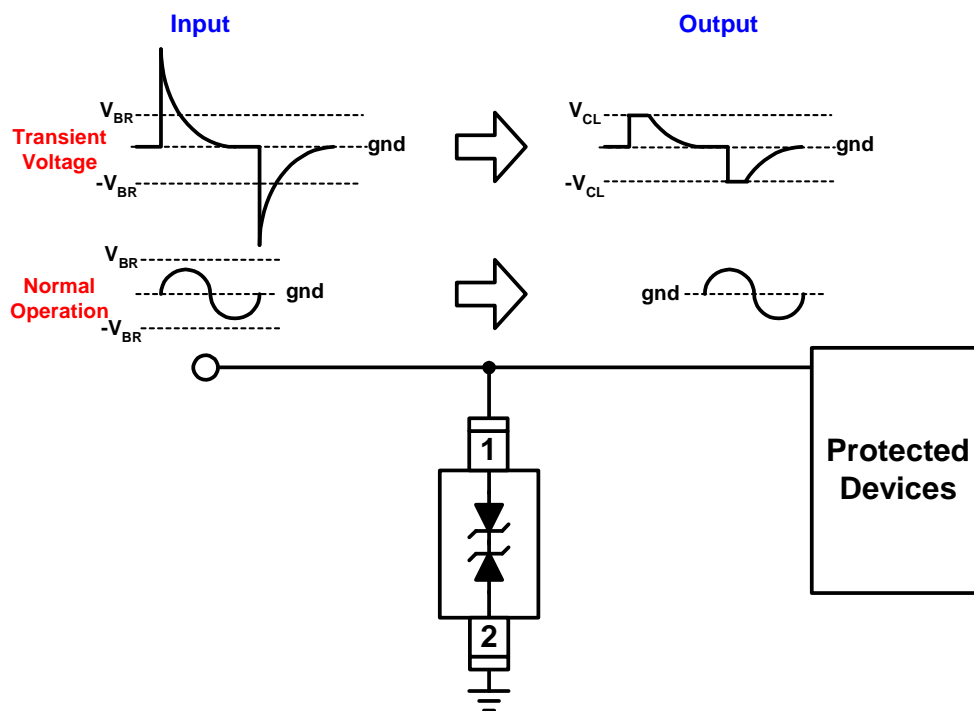
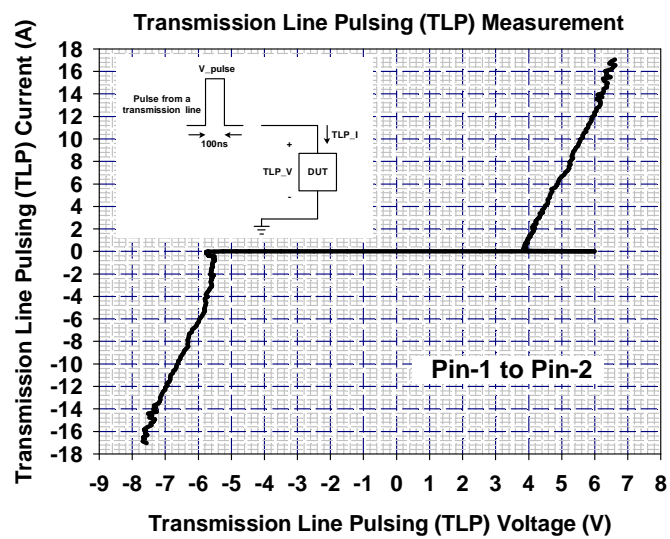
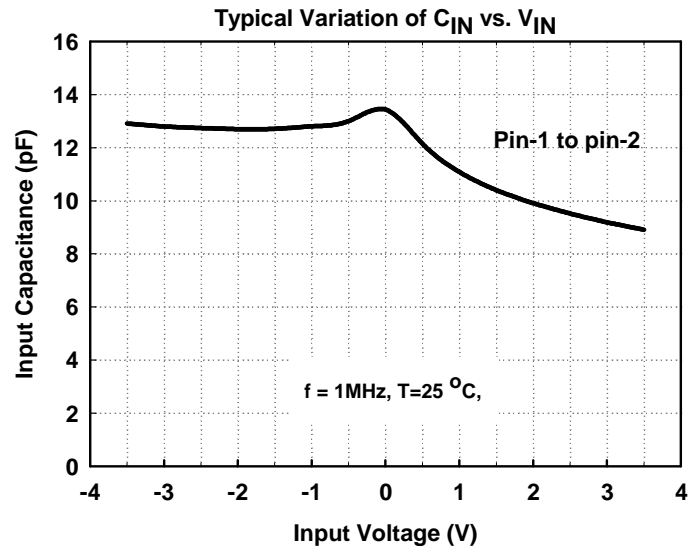


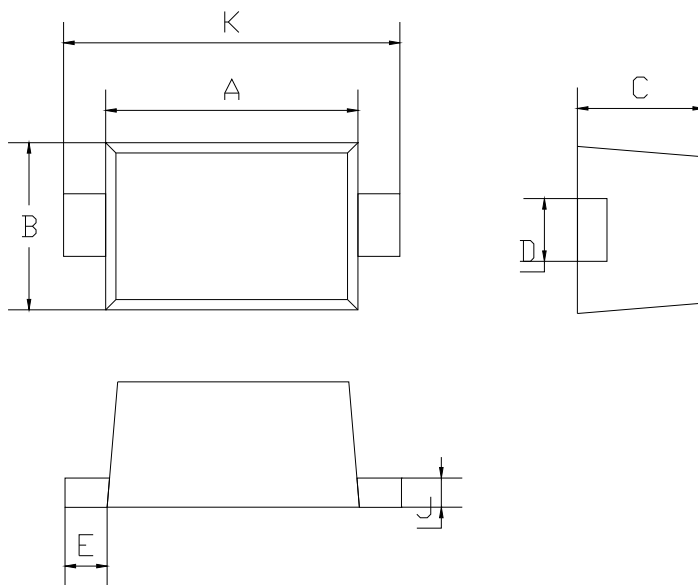
Fig. 1

Typical Characteristics



Plastic surface mounted package

SOD-523



SOD-523		
Dim	Min	Max
A	1.1	1.3
B	0.7	0.9
C	0.5	0.7
D	0.3 Typical	
E	0.15	0.25
J	0.1 Typical	
K	1.5	1.7
All Dimensions in mm		

SOLDERING FOOTPRINT

